

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

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application of: Chung-Shi Liu, et al.

Serial No. 10/791,014

Filed: March 2, 2004

For: Prevention of Post CMP Defects in

**CU/FSG Process** 

Confirmation No.: 1306

Group Art Unit: Unknown

Examiner: Unknown

## TRANSMITTAL

Mail Stop Amendment
Commissioner For Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

Enclosed are the following regarding the above-identified patent application:

- 1. Preliminary Amendment; and
- 2. Return Post Card.

The Commissioner is hereby authorized to charge payment of any fees associated with any of the papers submitted herewith or to credit any overpayment to Deposit Account No. 08-1394.

Respectfully submitted,

Wei Wei Jeang Reg. No. 33,305

Date:

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File: 24061.596

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22313-1450

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PRELIMINARY AMENDMENT

Mail Stop Amendment Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Dear Sir:

Prior to the initial examination of the referenced application, please amend the application as shown in the accompanying sections and reconsider the referenced application in light of the amendments.

Amendments to the Claims are reflected in the listing of claims which begins on page 2 of this paper.

Remarks/Arguments begin on page 8 of this paper.